

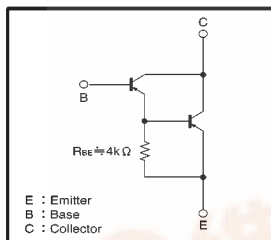
High-gain Amplifier Transistor (—32V, —0.3A)

2SB852K / 2SA830S

●Features

- 1) Darlington connection for high DC current gain.
- 2) Built-in 4 k Ω resistor between base and emitter.
- 3) Complements the 2SD1383K / 2SD1645S.

●Circuit diagram



●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV _{CEO}	—40	—	—	V	I _C =—100 μ A
Collector-emitter breakdown voltage	BV _{CEs}	—32	—	—	V	I _C =—1mA, R _{BE} =0
Emitter-base breakdown voltage	BV _{EB0}	—6	—	—	V	I _E =—100 μ A
Collector cutoff current	I _{CBO}	—	—	1	μ A	V _{CB} =—24V
Emitter cutoff current	I _{EB0}	—	—	1	μ A	V _{EB} =—4.5V
DC current transfer ratio	h _{FE}	5000	—	—	—	V _{CE} /I _C =—5V/—0.1A
Collector-emitter saturation voltage	V _{CE(sat)}	—	—	—1.5	V	I _C /I _E =—200mA/—0.4mA
Transition frequency	f _T	—	200	—	MHz	V _{CE} =—5V, I _E =—10mA, f=100MHz
Output capacitance	C _{ob}	—	3	—	pF	V _{CE} =—10V, I _E =0A, f=1MHz

*1 Measured using pulse current.

*2 Transition frequency of the device.

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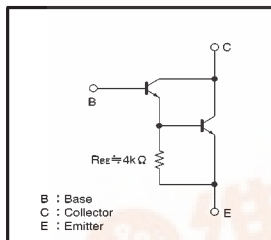
High-gain Amplifier Transistor (32V, 0.3A)

2SD1383K / 2SC1645S

●Features

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Collector-base breakdown voltage	BV _{CEO}	40	—	—	V	I _C =100 μ A
Collector-emitter breakdown voltage	BV _{CEs}	32	—	—	V	I _C =—1mA, R _{BE} =0 Ω
Emitter-base breakdown voltage	BV _{EB0}	6	—	—	V	I _E =100 μ A
Collector cutoff current	I _{CBO}	—	—	1	μ A	V _{CB} =24V
Emitter cutoff current	I _{EB0}	—	—	1	μ A	V _{EB} =4.5V
DC current transfer ratio	h _{FE}	5000	—	—	—	V _{CE} /I _C =5V/0.1A
Collector-emitter saturation voltage	V _{CE(sat)}	—	—	—1.5	V	I _C /I _E =200mA/0.4mA
Transition frequency	f _T	—	250	—	MHz	V _{CE} =5V, I _E =—10mA, f=100MHz
Output capacitance	C _{ob}	—	5	—	pF	V _{CE} =10V, I _E =0A, f=1MHz

*1 Measured using pulse current.

*2 Transition frequency of the device.

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V _{CEO}	—40	V
Collector-emitter voltage	V _{CEs}	—32	V
Emitter-base voltage	V _{EB0}	—6	V
Collector current	I _C	—0.3	A
Collector power dissipation	P _C	0.2	W
Junction temperature	T _J	150	°C
Storage temperature	T _{stg}	—55~+150	°C

* R_{BE}=0 Ω

●Packaging specifications and hFE

Type	2SB852K	2SA830S
Package	SMT3	SPT
h _{FE}	B	B
Marking	U*	—
Code	T146	TP
Basic ordering unit (pieces)	3000	5000

* Denotes h_{FE}

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	V _{CEO}	40	V
Collector-emitter voltage	V _{CEs}	32	V
Emitter-base voltage	V _{EB0}	6	V
Collector current	I _C	0.3	A (DC)
Collector power dissipation	P _C	0.2	W
Junction temperature	T _J	150	°C
Storage temperature	T _{stg}	—55~+150	°C

*1 Single pulse P_W=10ms *2 R_{BE}=0 Ω

●Packaging specifications and hFE

Type	2SD1383K	2SC1645S
Package	SMT3	SPT
h _{FE}	B	B
Marking	W*	—
Code	T146	TP
Basic ordering unit (pieces)	3000	5000

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